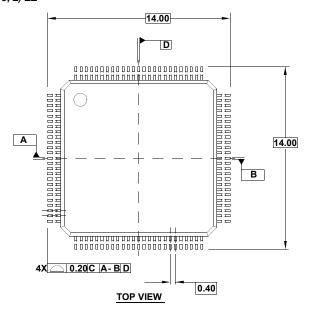
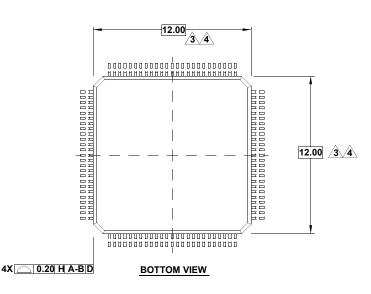
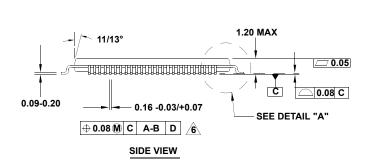
Package Outline Drawing

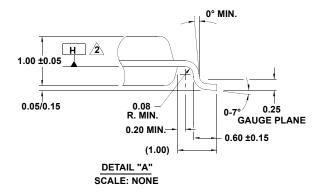
Q100.12x12A

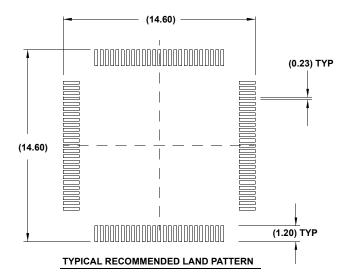
100 LEAD THIN PLASTIC QUAD FLATPACK PACKAGE (TQFP) Rev 0, 2/11











NOTES:

- 1. All dimensioning and tolerancing conform to ANSI Y14.5-1982.
- Datum plane ⊞ located at mold parting line and coincident with lead, where lead exits plastic body at bottom of parting line.
- 3. Dimensions do not include mold protrusion. Allowable mold protrusion is 0.25mm per side.
- 4. These dimensions to be determined at datum plane H.
- 5. Package top dimensions are smaller than bottom dimensions and top of package will not overhang bottom of package.
- Dimension does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm total at maximum material condition. Dambar cannot be located on the lower radius or the foot.
- 7. Controlling dimension: millimeter.
- 8. This outline conforms to JEDEC publication 95 registration MS-026, variation ADE.
- 9. Dimensions in () are for reference only.